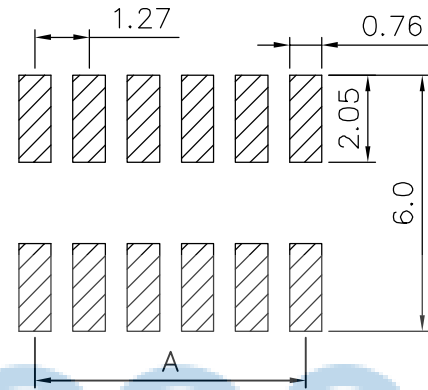
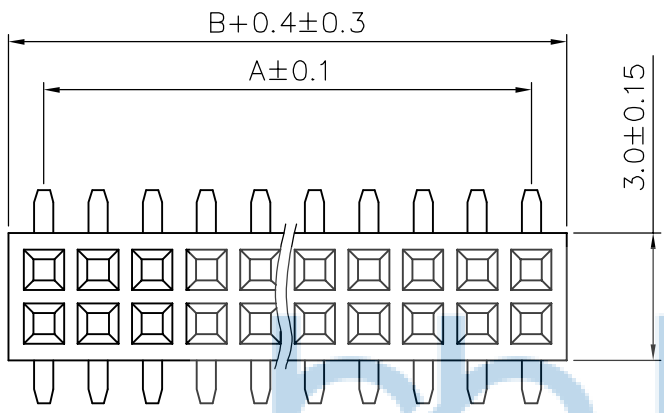


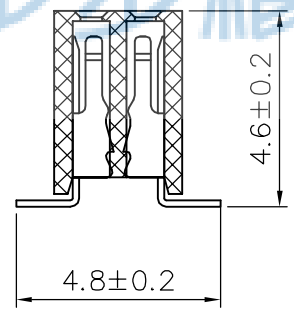
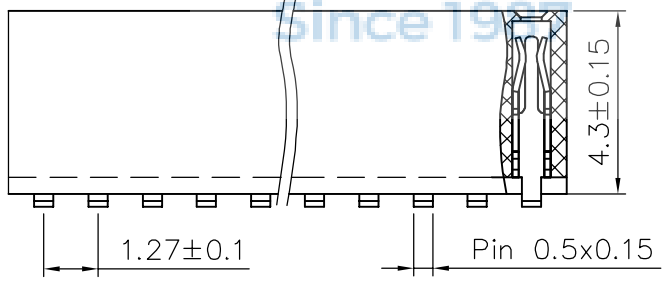
REV.	ECN NO	CONTENT	DATE	ENGINEER
A0		Initial release	/	SGF

SPECIFICATIONS

Current Rating: 1.0 Amps
 Withstanding Voltage: AC 500V
 Insulation Resistance: 1000M Ω Min
 Contact Resistance: 20 m Ω Max
 Operation Temperature: -40 ° to +105 °
 Insulator Material: Polyester (UL94V-0)
 Contact Material: Phosphor bronze
 Standard: PA6T
 Contact Plating: Gold Flash
 Max. Processing Temp: 240 ° C for 30-60 seconds
 (260 ° C for 5 seconds)



RECOMMEND P. C. B LAYOUT
 PCB TOLERANCE: ± 0.05 (TOP VIEW)



No. of	DIM. A	DIM. B	No. of	DIM. A	DIM. B	No. of	DIM. A	DIM. B	No. of	DIM. A	DIM. B	No. of	DIM. A	DIM. B
1	—	—	11	12.70	13.97	21	25.40	26.67	31	38.10	39.37	41	50.80	52.07
2	1.27	2.54	12	13.97	15.24	22	26.67	27.94	32	39.37	40.64	42	52.07	53.34
3	2.54	3.81	13	15.24	16.51	23	27.94	29.21	33	40.64	41.91	43	53.34	54.61
4	3.81	5.08	14	16.51	17.78	24	29.21	30.48	34	41.91	43.18	44	54.61	55.88
5	5.08	6.35	15	17.78	19.05	25	30.48	31.75	35	43.18	44.45	45	55.88	57.15
6	6.35	7.62	16	19.05	20.32	26	31.75	33.02	36	44.45	45.72	46	57.15	58.42
7	7.62	8.89	17	20.32	21.59	27	33.02	34.29	37	45.72	46.99	47	58.42	59.69
8	8.89	10.16	18	21.59	22.86	28	34.29	35.56	38	46.99	48.26	48	59.69	60.96
9	10.16	11.43	19	22.86	24.13	29	35.56	36.83	39	48.26	49.53	49	60.96	62.23
10	11.43	12.70	20	24.13	25.40	30	36.83	38.10	40	49.53	50.80	50	62.23	63.50



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PDWG.NO: 0266-1

DR. SGF

APPD. JM_Zheng

CHKD. LYX

NAME: 深圳市步步精科技有限公司
 排母 1.27FH H4.3 2x9P SMT PC4.8 U型 6T 贴膜编带

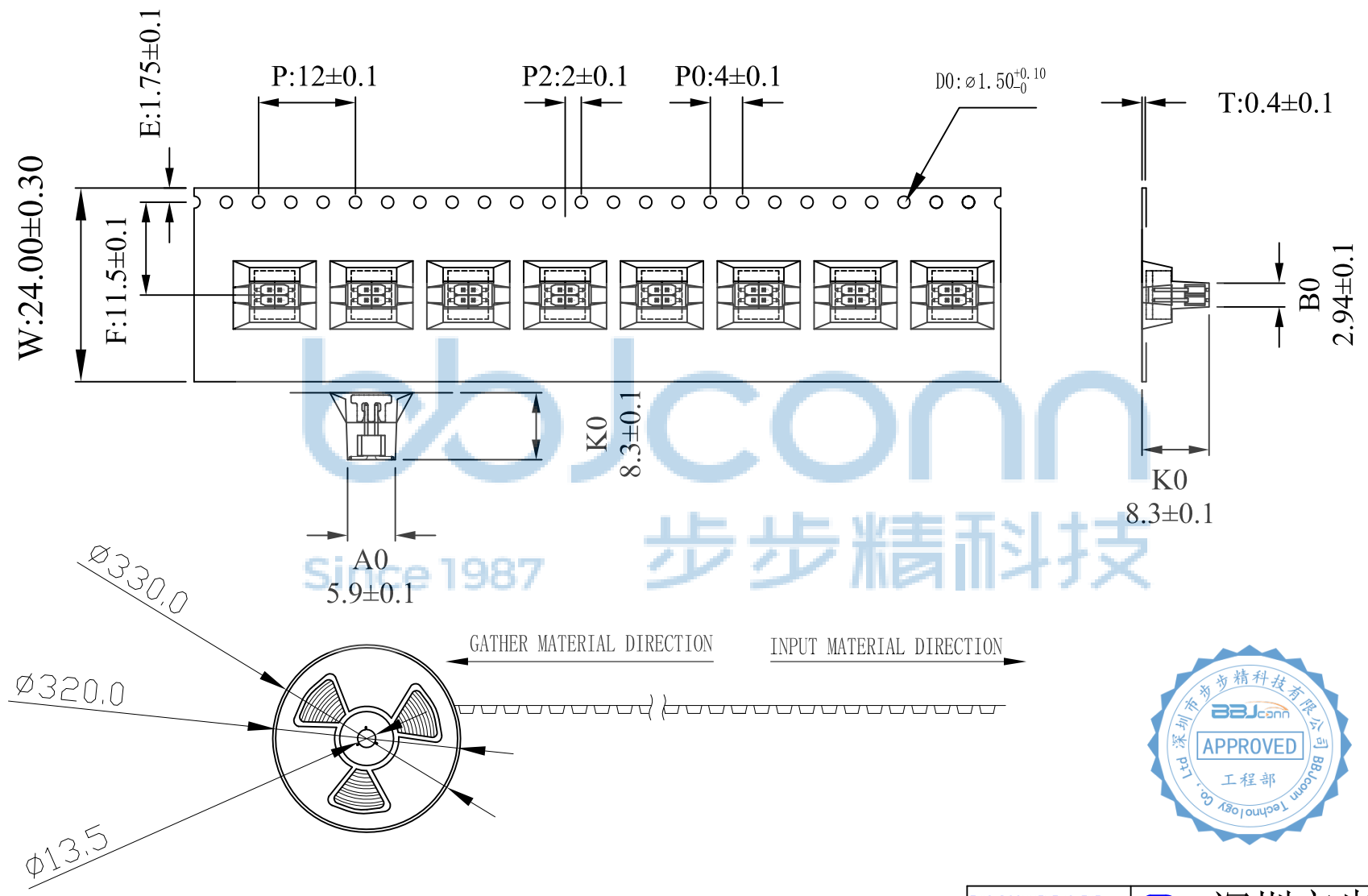
PJ. NO.: FH.03.22-23-3009

SIZE: A4 | DRW NO.:

FINISH: SEE NOTES | MAT'L.: SEE NOTES

SCALE: N/A | REV.: A0 | UNIT: mm | PAGE: 1/2

REV.	ECN NO.	CONTENT	DATE	ENGINEER
A0		Initial release	/	SGF
		W	24.00±0.3	
		F	11.50±0.1	
		T	0.40±0.05	
		E	1.75±0.1	
		P	12.00±0.1	
		P0	4±0.1	
		P2	2±0.1	
		A0	5.60±0.1	
		B0	2.94±0.1	
		K0	8.30±0.1	
		D0	1.50 ^{+0.1} ₋₀	



料号		载带宽度	W24	载带长度	7.68米
数量	800pcs/卷	装箱数量		卷盘外径	330mm/13寸
留空	20-600-20	上带规格	21.3mm*200米	冷封/热封	冷封
模具		下带颜色	雾透	下带材质	PS

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深圳市步步精科技有限公司

PDWG.NO: 0266-1

APPD.	JM_Zheng	NAME:	排母 1.27FH H4.3 2x9P SMT PC4.8 U型 6T 贴膜带
CHKD.	LYX	PJ. NO.:	FH.03.22-23-3009
DR.	SGF	SIZE: A4	DRW NO.:
		FINISH: SEE NOTES	MAT'L.: SEE NOTES
		SCALE: N/A	REV.: A0
		UNIT: mm	PAGE: 2/2